

800 V, 17 A, 290 mΩ

## Features

- Typ. R<sub>DS(on)</sub> = 0.245 Ω
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 58 nC)
- Low E<sub>oss</sub> (Typ. 5.6 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 240 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

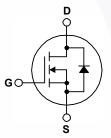
# Applications

- AC-DC Power Supply
- LED Lighting

# Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter			Unit	
V <sub>DSS</sub>	Drain to Source Voltage		800	V		
V <sub>GSS</sub>		- DC		±20	V	
	Gate to Source Voltage	- AC	(f >1 Hz)	±30	V	
ID	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		17*	٨	
		- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		10.8*	— A	
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)		42*	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			882	mJ	
I <sub>AR</sub>	Avalanche Current	3.4	Α			
E <sub>AR</sub>	Repetitive Avalanche Energy	2.12	mJ			
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)				20	
P <sub>D</sub>	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		40	W	
	Power Dissipation	- Derate Above 25°C		0.32	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

# Thermal Characteristics

Symbol	Parameter	FCPF290N80	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.15	00044	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	− °C/W	

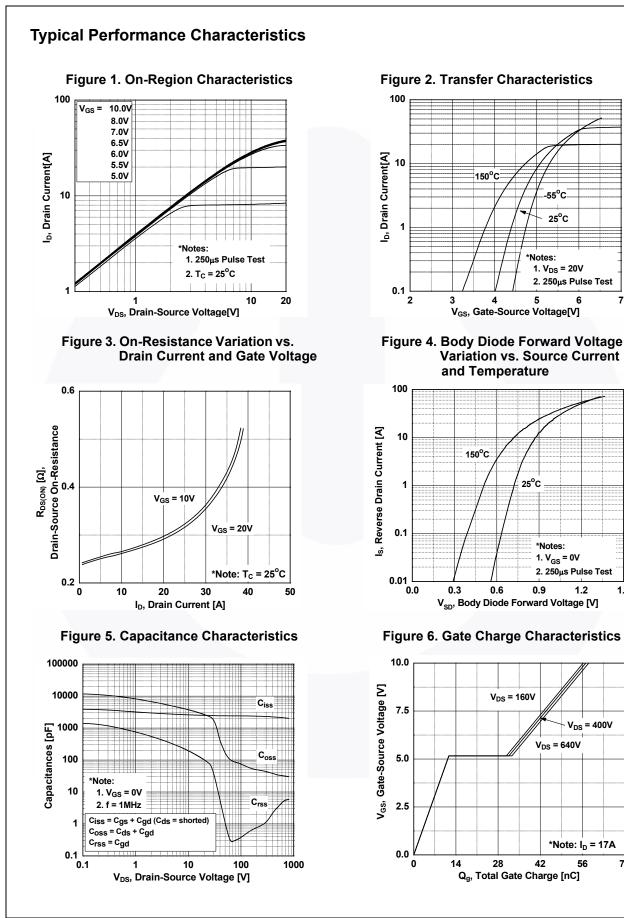
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Part Nu	· · · · · · · · · · · · · · · · · · ·		Package	Packing Method	Reel Size	Э	Tape Width	n Qu	Quantity 50 units	
FCPF2			TO-220F	Tube	N/A		N/A	50		
Electrica	l Chara	icteristics T <sub>C</sub> = 25%	C unless oth	erwise noted.						
Symbol	Parameter			Test Conditions			Тур.	Max.	Unit	
Off Charac	teristics									
BV <sub>DSS</sub>				= 0 (1 - 1 m A T)	- 2500	800	-	-	V	
∆BV <sub>DSS</sub>	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient			$V_{GS} = 0 V, I_D = 1 mA, T_J = 25^{\circ}C$		000	-	-		
ΔDV <sub>DSS</sub> / ΔT <sub>.1</sub>			I <sub>D</sub> =	I <sub>D</sub> = 1 mA, Referenced to 25 <sup>o</sup> C			0.8	-	V/ºC	
		Zero Gate Voltage Drain Current		$V_{DS}$ = 800 V, $V_{GS}$ = 0 V $V_{DS}$ = 640 V, $T_{C}$ = 125°C		-	-	25	- μΑ	
DSS	Zero Gat					-	-	250		
I <sub>GSS</sub>	Gate to Body Leakage Current		V <sub>G</sub>	<sub>S</sub> = ±20 V, V <sub>DS</sub> = 0 V		-	-	±100	nA	
On Charac	teristics									
V <sub>GS(th)</sub>	-	eshold Voltage	Vo	<sub>S</sub> = V <sub>DS</sub> , I <sub>D</sub> = 1.7 mA		2.5	-	4.5	V	
R <sub>DS(on)</sub>		ain to Source On Resistan	-	$V_{GS} = V_{DS}, I_D = 1.7 \text{ mA}$ $V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$			245	290	mΩ	
9FS		Transconductance	0	$_{\rm S}$ = 20 V, I <sub>D</sub> = 8.5 A		-	20	-	S	
	_			3 , 0 , 1					-	
Dynamic C	haracte	ristics								
C <sub>iss</sub>	Input Capacitance		V	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	2410	3205	pF	
C <sub>oss</sub>	Output C	utput Capacitance					75	100	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance		ľ				0.36	-	pF	
C <sub>oss</sub>	Output Capacitance			V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	35	-	pF	
C <sub>oss(eff.)</sub>	Effective Output Capacitance		VD	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	240	-	pF	
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V	VD	<sub>S</sub> = 640 V, I <sub>D</sub> = 17 A,		-	58	75	nC	
Q <sub>gs</sub>	Gate to S	Source Gate Charge	V <sub>G</sub>	V <sub>GS</sub> = 10 V (Note 4)		-	11	-	nC	
Q <sub>gd</sub>	Gate to D	orain "Miller" Charge				-	22	-	nC	
ESR	Equivalent Series Resistance		f =	f = 1 MHz			0.75	-	Ω	
Switching	Charact	eristics								
t <sub>d(on)</sub>		Delay Time				-	22	54	ns	
t <sub>r</sub>	Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time		VD	<sub>D</sub> = 400 V, I <sub>D</sub> = 17 A,		-	14	38	ns	
t <sub>d(off)</sub>			V <sub>G</sub>	$V_{GS}$ = 10 V, R <sub>g</sub> = 4.7 $\Omega$ (Note 4)		-	61	132	ns	
t <sub>f</sub>						-	2.6	15	ns	
	ree Died	e Characteristics			. ,	6			1	
I <sub>S</sub>	-	Continuous Drain to Sou	rce Diode F	orward Current			-	17	A	
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode					-	-	42	A	
V <sub>SD</sub>	Drain to Source Diode Forward Voltage			$V_{GS} = 0 V, I_{SD} = 17 A$		-	-	1.2	V	
t <sub>rr</sub>		Recovery Time	0	<sub>S</sub> = 0 V, I <sub>SD</sub> = 17 A,		-	511	-	ns	
Q <sub>rr</sub>		Recovery Charge		$dl_{F}/dt = 100 A/\mu s$		-	12	-	μC	
Notes: 1. Repetitive rating	: pulse-width lii	mited by maximum junction temper 25 Ω, starting TJ = 25°C.		nu - 100 rups		-	12	Ú	μ	

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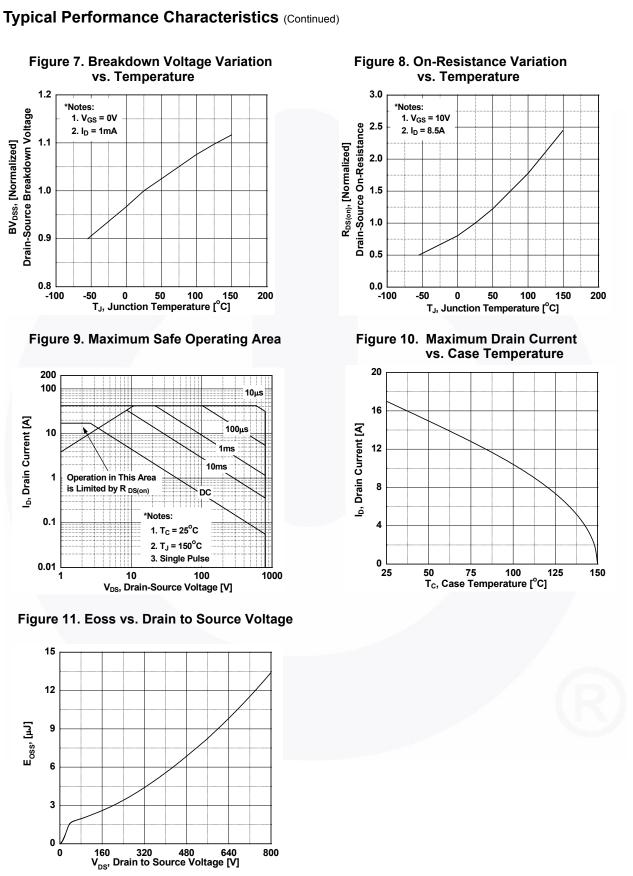


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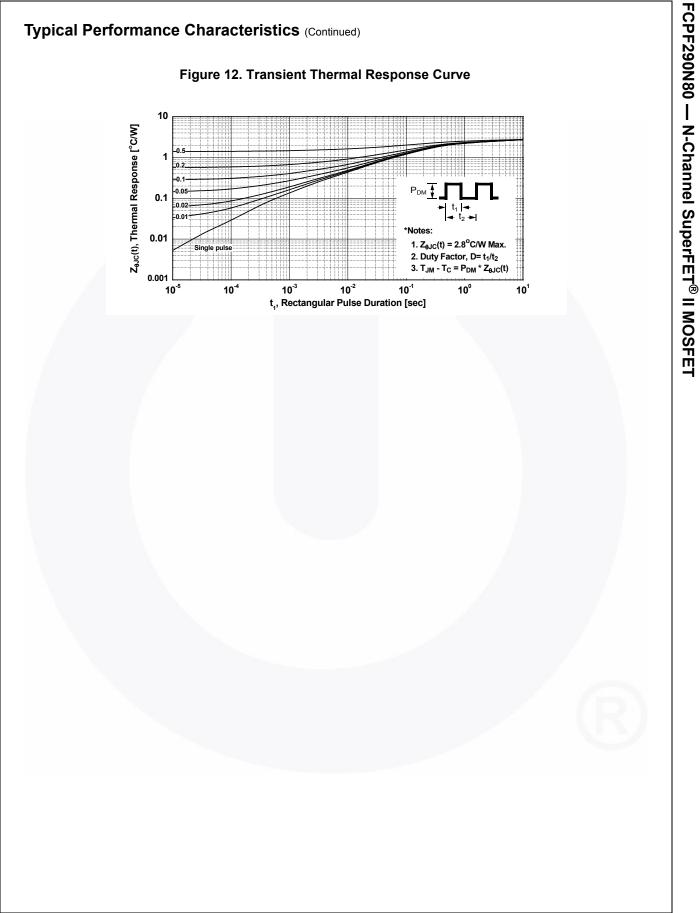
Drain-Source Breakdown Voltage

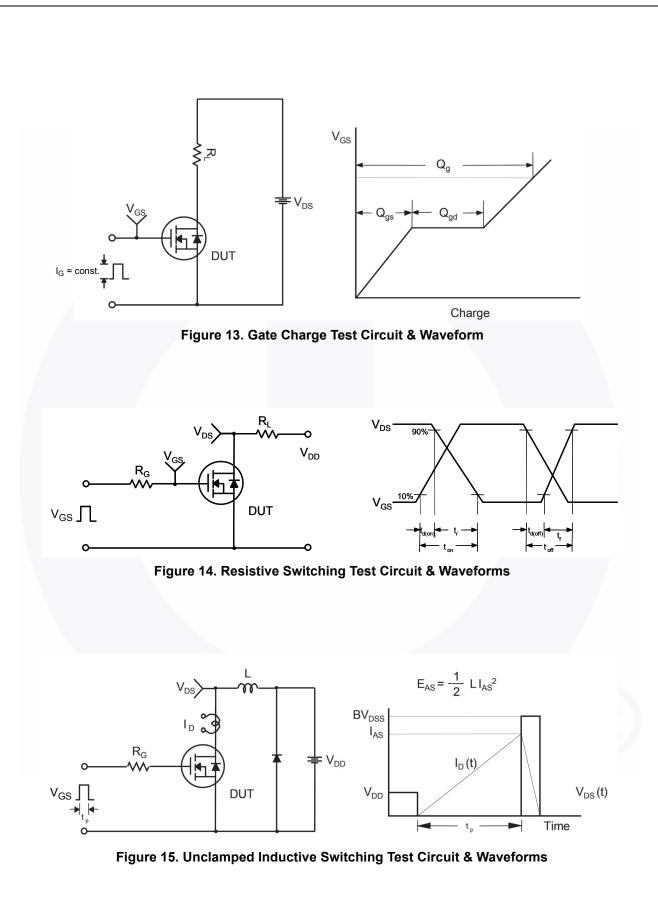
I<sub>D</sub>, Drain Current [A]

E<sub>oss</sub>, [µJ]

BV<sub>DSS</sub>, [Normalized]

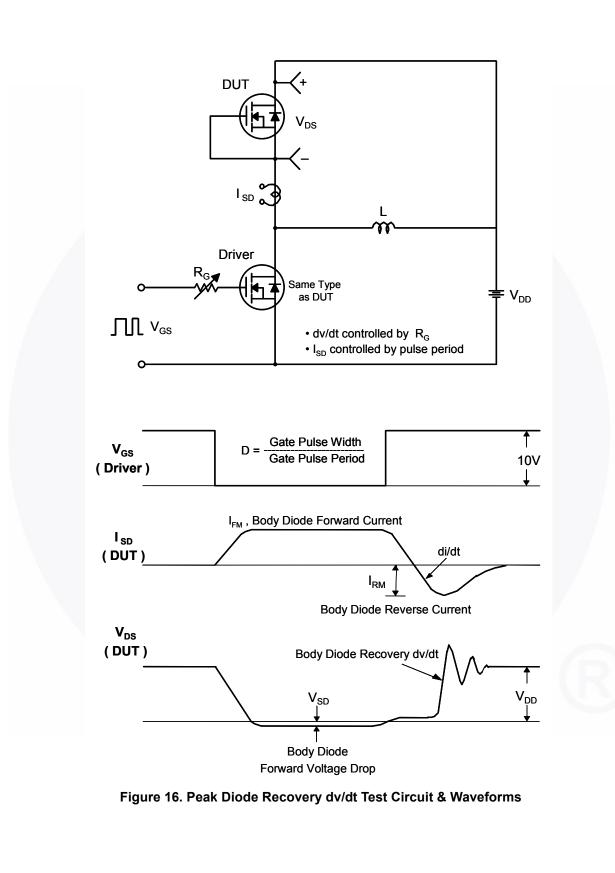
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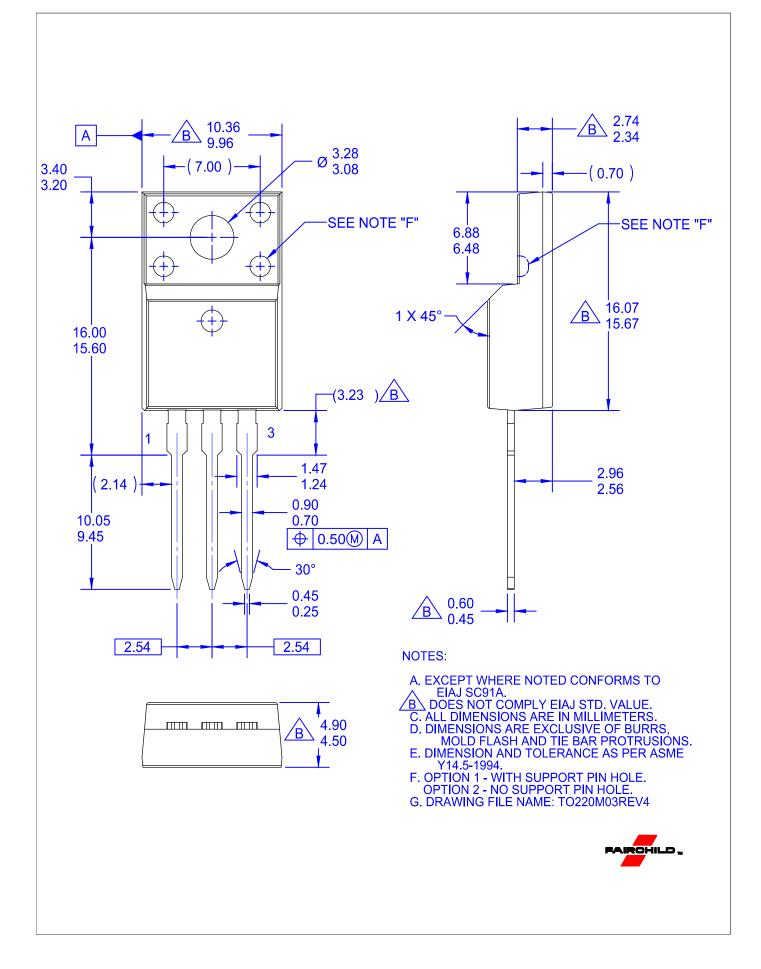




FCPF290N80 — N-Channel SuperFET<sup>®</sup> II MOSFET

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